

# PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

| <b>SUBMISSION TYPE:</b>  | NEW ASSIGNMENT   |               |                        |                            |  |                  |                    |                       |           |
|--|--|---------------|------------------------|----------------------------|--|------------------|--------------------|-----------------------|-----------|
| <b>NATURE OF CONVEYANCE:</b>   | ASSIGNMENT   |               |                        |                            |  |                  |                    |                       |           |
| <b>CONVEYING PARTY DATA</b>  |  |               |                        |                            |  |                  |                    |                       |           |
| <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Chiou-Fu Wang</td> <td>01/04/2010</td> </tr> <tr> <td>Huo-Hsien Chiang</td> <td>01/04/2010</td> </tr> </tbody> </table>  |  | Name          | Execution Date         | Chiou-Fu Wang              | 01/04/2010   | Huo-Hsien Chiang | 01/04/2010         |                       |           |
| Name   | Execution Date   |               |                        |                            |  |                  |                    |                       |           |
| Chiou-Fu Wang  | 01/04/2010   |               |                        |                            |  |                  |                    |                       |           |
| Huo-Hsien Chiang   | 01/04/2010   |               |                        |                            |  |                  |                    |                       |           |
| <b>RECEIVING PARTY DATA</b>  |  |               |                        |                            |  |                  |                    |                       |           |
| <table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;"><b>Name:</b></td> <td>Du Pont Apollo Limited</td> </tr> <tr> <td><b>Street Address:</b></td> <td>Units 501-509, West Wing, Lakeside 1 Bldg., No. 8 Science Park W. Ave., Hong Kong Science Park</td> </tr> <tr> <td><b>City:</b></td> <td>Pak Shek Kok, N.T.</td> </tr> <tr> <td><b>State/Country:</b></td> <td>HONG KONG</td> </tr> </table>      |  | <b>Name:</b>  | Du Pont Apollo Limited | <b>Street Address:</b>     | Units 501-509, West Wing, Lakeside 1 Bldg., No. 8 Science Park W. Ave., Hong Kong Science Park | <b>City:</b>     | Pak Shek Kok, N.T. | <b>State/Country:</b> | HONG KONG |
| <b>Name:</b>   | Du Pont Apollo Limited   |               |                        |                            |  |                  |                    |                       |           |
| <b>Street Address:</b>   | Units 501-509, West Wing, Lakeside 1 Bldg., No. 8 Science Park W. Ave., Hong Kong Science Park |               |                        |                            |  |                  |                    |                       |           |
| <b>City:</b>   | Pak Shek Kok, N.T.   |               |                        |                            |  |                  |                    |                       |           |
| <b>State/Country:</b>  | HONG KONG  |               |                        |                            |  |                  |                    |                       |           |
| <b>PROPERTY NUMBERS Total: 1</b>   |  |               |                        |                            |  |                  |                    |                       |           |
| <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td><b>Application Number:</b></td> <td>12963251</td> </tr> </tbody> </table>   |  | Property Type | Number                 | <b>Application Number:</b> | 12963251   |                  |                    |                       |           |
| Property Type  | Number   |               |                        |                            |  |                  |                    |                       |           |
| <b>Application Number:</b>   | 12963251   |               |                        |                            |  |                  |                    |                       |           |
| <b>CORRESPONDENCE DATA</b>   |  |               |                        |                            |  |                  |                    |                       |           |
| <p><b>Fax Number:</b> (914)579-2201</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p><b>Phone:</b> 914-579-2200</p> <p><b>Email:</b> dukanemail@duganpatent.com</p> <p><b>Correspondent Name:</b> Dugan &amp; Dugan, PC</p> <p><b>Address Line 1:</b> 245 Saw Mill River Rd., Suite 309</p> <p><b>Address Line 2:</b> Brian M. Dugan</p> <p><b>Address Line 4:</b> Hawthorne, NEW YORK 10532</p> |  |               |                        |                            |  |                  |                    |                       |           |
| <b>ATTORNEY DOCKET NUMBER:</b>   | TLC-009  |               |                        |                            |  |                  |                    |                       |           |
| <b>NAME OF SUBMITTER:</b>  | Brian M. Dugan   |               |                        |                            |  |                  |                    |                       |           |
| <p><b>Total Attachments: 2</b></p> <p>source=56639#page1.tif</p> <p>source=56639#page2.tif</p>   |  |               |                        |                            |  |                  |                    |                       |           |

OP \$40.00 12963251

501393941

**PATENT**  
**REEL: 025559 FRAME: 0684**

## ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title) \_\_\_\_\_  
METHOD OF MAKING MONOLITHIC PHOTOVOLTAIC MODULE ON FLEXIBLE  
SUBSTRATE

The PATENT RIGHTS referred to in this agreement are:

(check one) ☒ a patent application for this invention, executed by the ASSIGNOR(S)  
concurrently with this assignment.

☐ U.S. patent application Serial No. \_\_\_\_\_, filed \_\_\_\_\_

☐ a U.S. patent application based on PCT International Application

No. \_\_\_\_\_ filed on (date) \_\_\_\_\_ (U.S. patent application  
Serial No. \_\_\_\_\_, if known).

☐ U.S. patent No. \_\_\_\_\_, issued \_\_\_\_\_.

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of  
the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

(check one) ☒ U.S. patent rights only.

☐ Worldwide patent rights. In this case, the assignee shall have the right to  
claim the benefit of the filing date of any U.S. or foreign patent application  
for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures  
appear on page 2 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) Du Pont Apollo Limited

(Address) Units 501-509, West Wing, Lakeside 1 Building, No. 8 Science Park West  
Avenue, Hong Kong Science Park, Pak Shek Kok, N.T., Hong Kong

The ASSIGNEE is:

(check one) ☐ An individual.

☐ A Partnership.

☒ A Corporation of Hong Kong (specify state or country)

☐ (other) \_\_\_\_\_

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and  
valuable consideration, receipt of which is acknowledged, hereby assign(s) the following  
rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;

the entire right, title and interest in and to the PATENT RIGHTS;

the right to sue and recover for any past infringement; and

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable  
provisions, based on any earlier patent applications for this invention.

PATENT

REEL: 025559 FRAME: 0685

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO  
 ASSIGNEE: Du Pont Apollo Limited  
 INVENTION TITLE: METHOD OF MAKING MONOLITHIC PHOTOVOLTAIC  
 MODULE ON FLEXIBLE SUBSTRATE

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

|   |                      |                   |
|---|----------------------|-------------------|
| <u>Chiou-Fu WANG</u>                      | <u>Chiou-Fu Wang</u> | <u>1/4/2010</u>   |
| Name of sole or first inventor            | Signature            | Date              |
| <u>Huo-Hsien CHIANG</u>                   | <u>Chiang</u>        | <u>Jan 4 2010</u> |
| Name of second inventor, if any           | Signature            | Date              |
| _____<br>Name of third inventor, if any   | _____<br>Signature   | _____<br>Date     |
| _____<br>Name of fourth inventor, if any  | _____<br>Signature   | _____<br>Date     |
| _____<br>Name of fifth inventor, if any   | _____<br>Signature   | _____<br>Date     |
| _____<br>Name of sixth inventor, if any   | _____<br>Signature   | _____<br>Date     |
| _____<br>Name of seventh inventor, if any | _____<br>Signature   | _____<br>Date     |

\_\_\_\_\_  
Name of eighth inventor, if any

\_\_\_\_\_  
Signature

\_\_\_\_\_  
Date **PATENT**